

IEC SYSTEM FOR MUTUAL RECOGNITION OF TEST  
CERTIFICATES FOR ELECTRICAL EQUIPMENT  
(IECEE) CB SCHEME

SYSTEME CEI D'ACCEPTATION MUTUELLE DE  
CERTIFICATS D'ESSAIS DES EQUIPEMENTS  
ELECTRIQUES (IECEE) METHODE OC

**CB TEST CERTIFICATE****CERTIFICAT D'ESSAI OC**

Product  
Produit

Blade Server

Name and address of the applicant  
Nom et adresse du demandeur

FOXCONN INTERNATIONAL INC  
NO 2 ZIYOU ST TUCHENG DISTRICT NEW TAIPEI, 236  
TAIWAN

Name and address of the manufacturer  
Nom et adresse du fabricant

HEWLETT-PACKARD COMPANY  
11445 COMPAQ CENTER DR W HOUSTON, TX 77070  
United States of America

Name and address of the factory  
Nom et adresse de l'usine

HEWLETT-PACKARD SINGAPORE (PTE) LTD  
452 ALEXANDRA RD SINGAPORE 119961  
SINGAPORE

Note: When more than one factory, please report on page 2  
Note: Lorsque il y plus d'une usine, veuillez utiliser la 2<sup>ème</sup> page

Additional Information on page 2

Ratings and principal characteristics  
Valeurs nominales et caractéristiques principales

12Vdc, 40A MAX

Trademark (if any)  
Marque de fabrique (si elle existe)  
Type of Manufacturer's Testing Laboratories used  
Type de programme du laboratoire d'essais  
constructeur

hp

Model / Type Ref.  
Ref. De type

HSTNS-BC59-S

Additional information (if necessary may also be  
reported on page 2)  
Les informations complémentaires (si nécessaire,,  
peuvent être indiqués sur la 2<sup>ème</sup> page

Additionally evaluated to EN 60950-1:2006 /A11:2009/A1:2010/  
A12:2011/ A2:2013; National Differences specified in the CB  
Test Report.

Additional Information on page 2

A sample of the product was tested and found  
to be in conformity with  
Un échantillon de ce produit a été essayé et a été  
considéré conforme à la

IEC 60950-1(ed.2), IEC 60950-1(ed.2);am1, IEC 60950-  
1(ed.2);am2

As shown in the Test Report Ref. No. which forms  
part of this Certificate  
Comme indiqué dans le Rapport d'essais numéro de  
référence qui constitue partie de ce Certificat

ACSCBIT14013-02 issued on 2015-04-30

This CB Test Certificate is issued by the National Certification Body

Ce Certificat d'essai OC est établi par l'Organisme **National de Certification**



UL (US), 333 Pfingsten Rd IL 60062, Northbrook, USA

UL (Denko), Borupvang 5A DK-2750 Ballerup, DENMARK

UL (JP), Marunouchi Trust Tower Main Building 6F, 1-8-3 Marunouchi, Chiyoda-ku, Tokyo 100-0005, JAPAN

UL (CA), 7 Underwriters Road, Toronto, M1R 3B4 Ontario, CANADA

For full legal entity names see [www.ul.com/ncbnames](http://www.ul.com/ncbnames)

Date: 2015-04-30

Original Issue Date: 2014-07-25

Signature:

Jan-Erik Storgaard



Factories:

HEWLETT-PACKARD JAPAN LTD  
3927-7 HAIJIMA-CHO AKISHIMA-SHI TOKYO 196-0002  
JAPAN

HEWLETT-PACKARD COMPANY  
11445 COMPAQ CENTER DR W HOUSTON, TX 77070  
United States of America

FOXCONN TECHNOLOGY CZ S R O  
KARLOV 245 284 01 KUTNA HORA  
CZECH REPUBLIC

SHANGHAI HEWLETT-PACKARD CO LTD  
2727 JINKE RD ZHANGJIANG HIGH-TECH PARK SHANGHAI 201203  
CHINA

ECMMS S A DE C V  
BLVD OSCAR FLORES SANCHEZ 8951 COL PUENTE ALTO 32690 JUAREZ CHIH  
MEXICO

HEWLETT-PACKARD COMPUTADORES LTDA  
RODOVIA SP340 - KM 118, 5 BLOCO C 13086-502 CAMPINAS- SP  
BRAZIL

HONG FU JIN PRECISION ELECTRONICS(TIANJIN) CO LTD  
NO 36 NORTH ST WEST ZONE ECONOMIC & TECHNOLOGICAL DEVELOPMENT AREA TIANJIN 300462  
CHINA

Additional Information:

The original report was modified to include the following changes/additions:  
Update alternate critical components table.

**Additional information (if necessary)**

**Information complémentaire (si nécessaire)**



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